

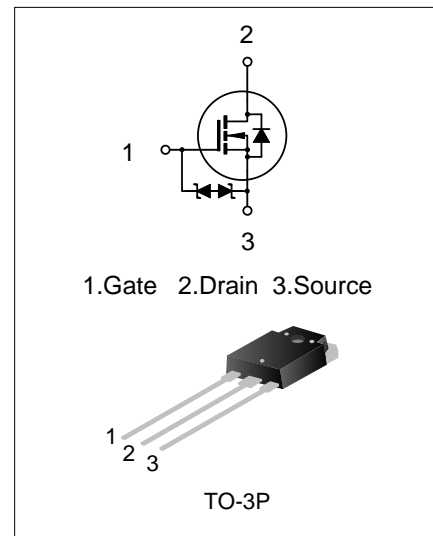
9A, 900V N-CHANNEL MOSFET

DESCRIPTION

SVF3878PN is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are widely used in AC-DC power suppliers, DC-DC converters and H-bridge PWM motor drivers.

FEATURES

- ◆ 9A, 900V, $R_{DS(on)}(typ.)=1.0\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low Crss
- ◆ Fast switching
- ◆ Improved dv/dt capability



ORDERING INFORMATION

Part No.	Package	Marking	Material	Packing
SVF3878PN	TO-3P	3878	Pb free	Tube

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, $T_A=25^\circ\text{C}$)

Characteristics	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	900	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current	I_D	$T_C=25^\circ\text{C}$	9.0
		$T_C=100^\circ\text{C}$	5.7
Drain Current Pulsed	I_{DM}	27.0	A
Power Dissipation ($T_C=25^\circ\text{C}$) -Derate above 25°C	P_D	150	W
		1.2	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy (Note 1)	E_{AS}	966	mJ
Operation Junction Temperature Range	T_J	$-55\sim+150$	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	$-55\sim+150$	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.83	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, T_c=25°C)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	B _{VDSS}	V _{GS} =0V, I _D =250μA	900	--	--	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =900V, V _{GS} =0V	--	--	100	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	--	--	±10.0	μA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250μA	2.5	--	4.5	V
On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =4.5A	--	1.0	1.28	Ω
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	--	2009	--	pF
Output Capacitance	C _{oss}		--	208	--	
Reverse Transfer Capacitance	C _{rss}		--	47	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} =400V, R _G =25Ω, I _D =4.0A (Note2,3)	--	22	--	ns
Turn-on Rise Time	t _r		--	28	--	
Turn-off Delay Time	t _{d(off)}		--	84	--	
Turn-off Fall Time	t _f		--	30	--	
Total Gate Charge	Q _g	V _{DD} =450V, V _{GS} =10V, I _D =9.0A (Note 2,3)	--	68	--	nC
Gate-Source Charge	Q _{gs}		--	10	--	
Gate-Drain Charge	Q _{gd}		--	39	--	

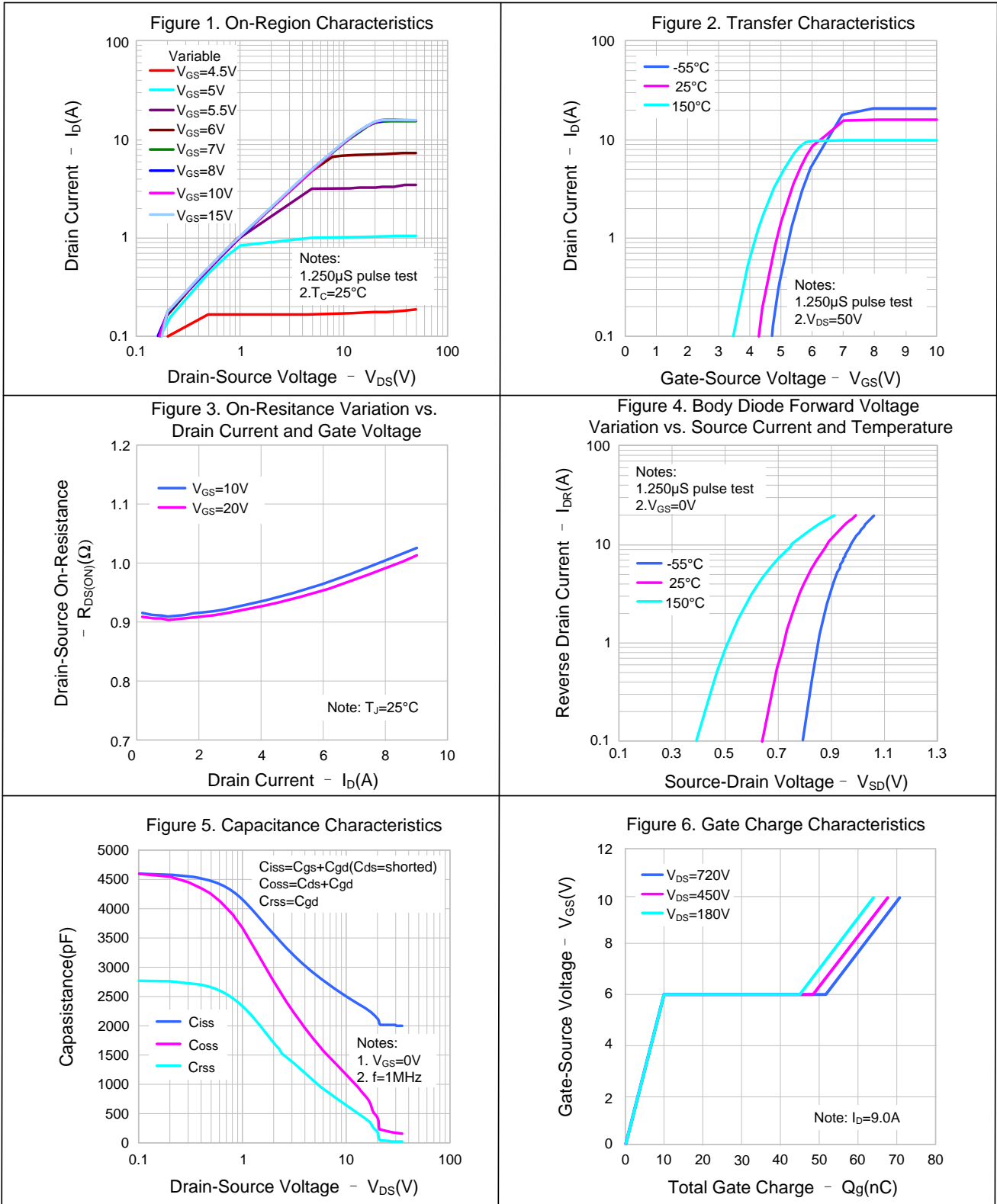
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Source Current	I _S	Integral Reverse P-N Junction Diode in the MOSFET	--	--	9.0	A
Pulsed Source Current	I _{SM}		--	--	27	
Diode Forward Voltage	V _{SD}	I _S =9.0A, V _{GS} =0V	--	--	1.4	V
Reverse Recovery Time	T _{rr}	I _S =9.0A, V _{GS} =0V, di/dt=100A/μS (Note2)	--	715	--	ns
Reverse Recovery Charge	Q _{rr}		--	6.5	--	μC

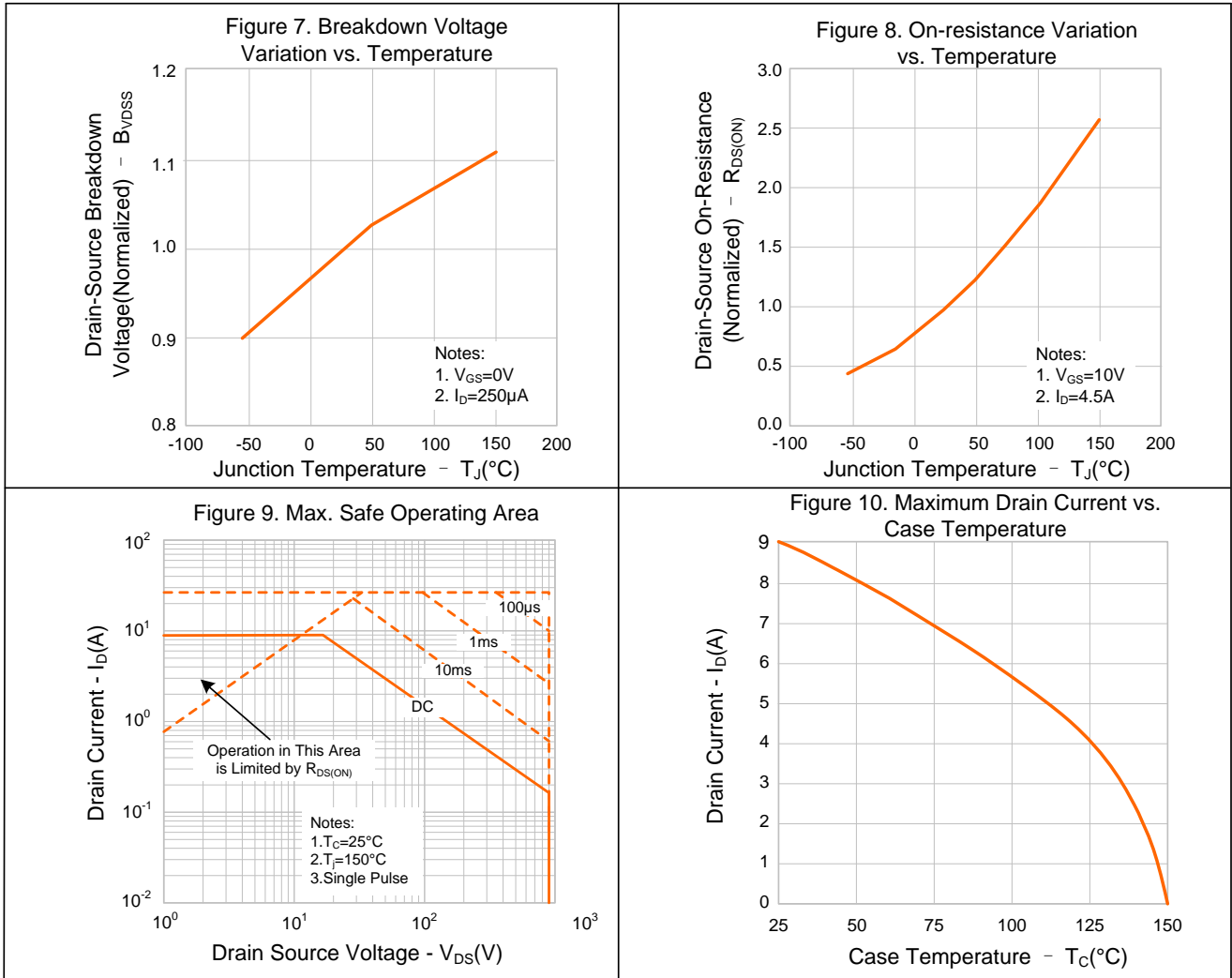
Notes:

1. L=30mH, I_{AS}=7.70A, V_{DD}=100V, R_G=25Ω, starting T_J=25°C;
2. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
3. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

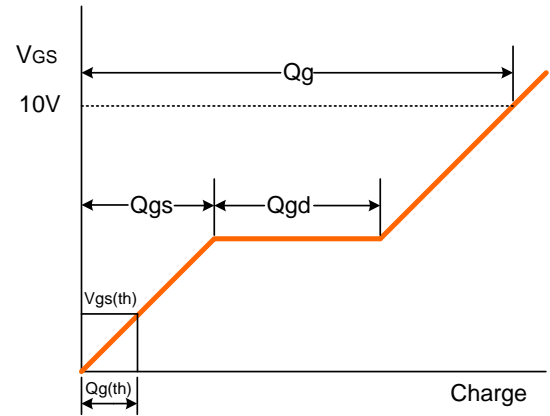
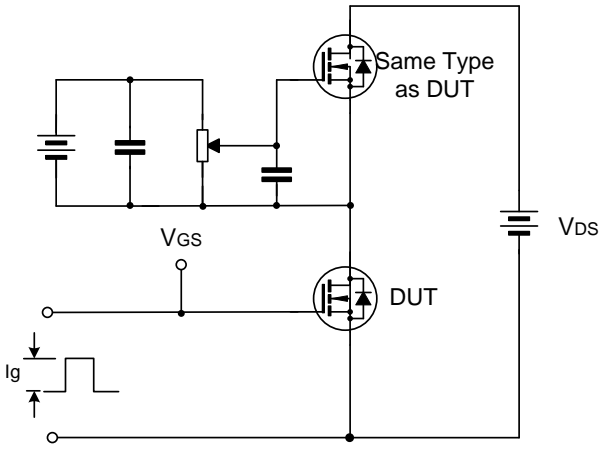


TYPICAL CHARACTERISTICS (CONTINUED)

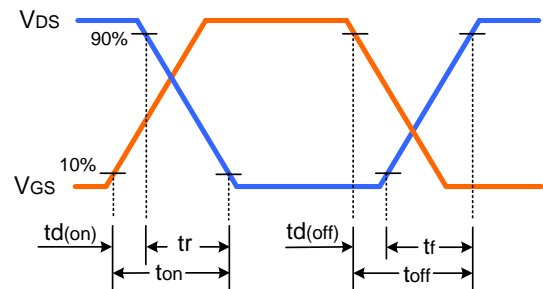
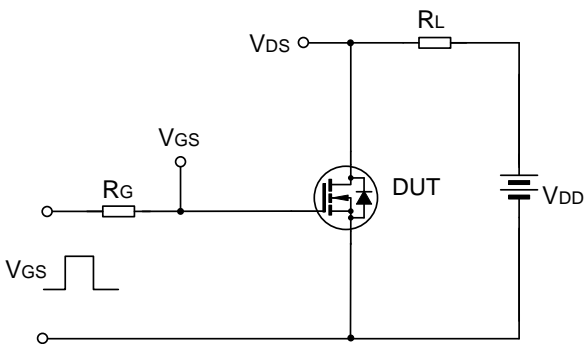


TYPICAL TEST CIRCUIT

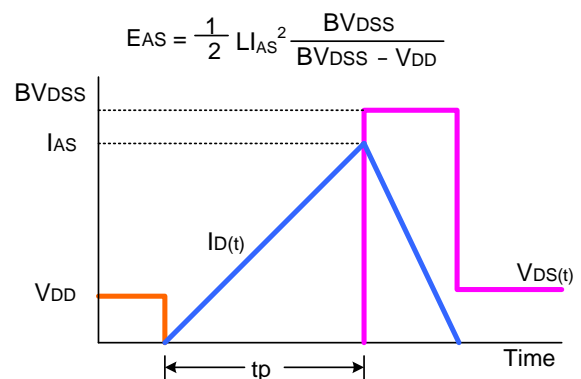
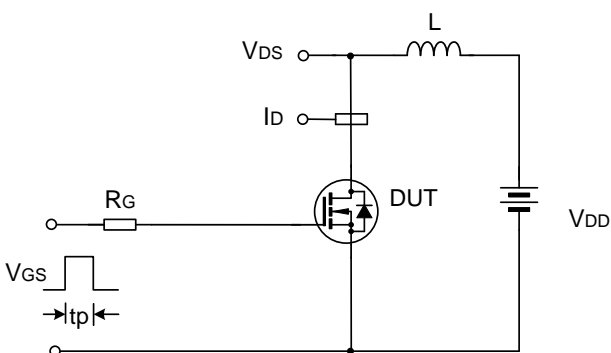
Gate Charge Test Circuit & Waveform



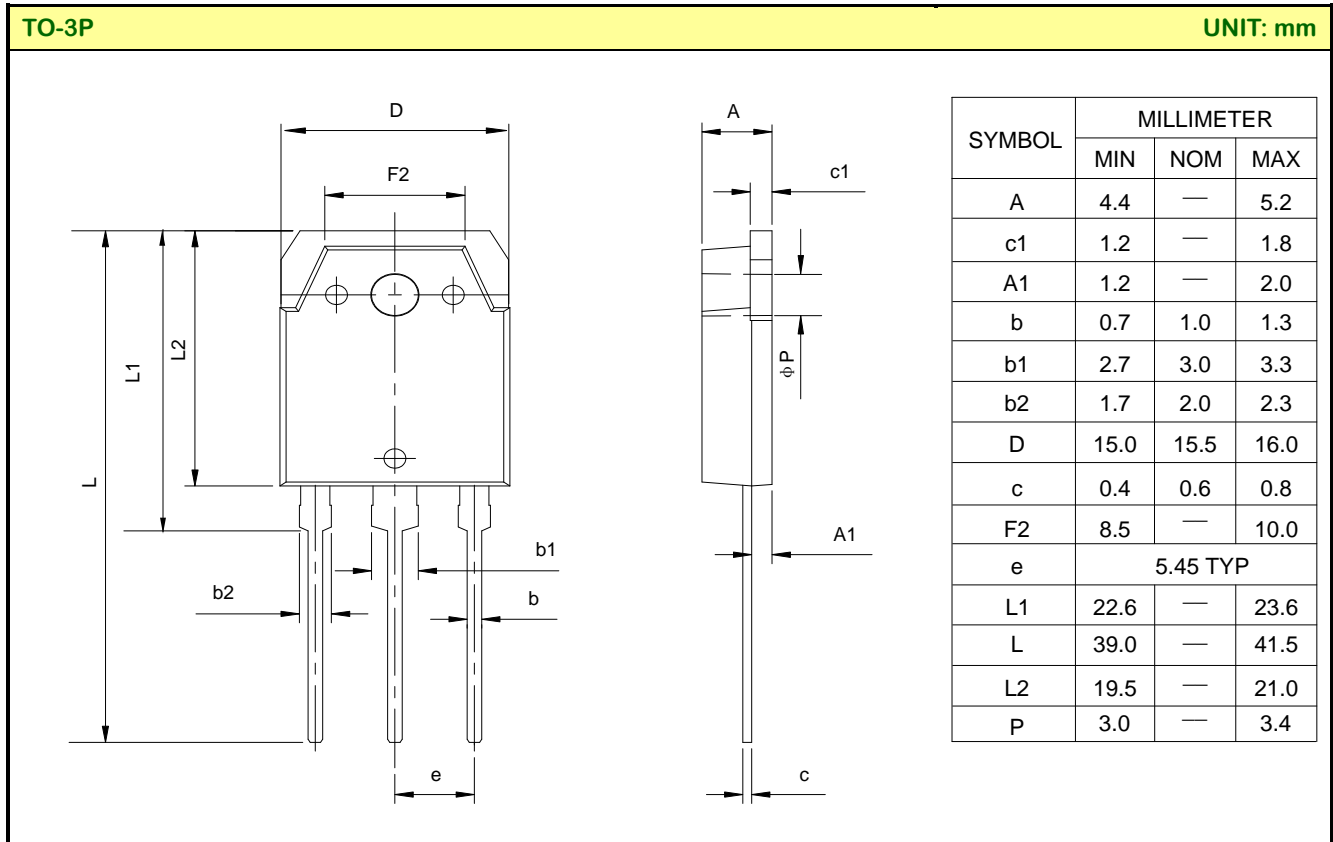
Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE



Important notice :

1. The instructions are subject to change without notice !
2. Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current. Please read the instructions carefully before using our products, including the circuit operation precautions.
3. Our products are consumer electronic products or the other civil electronic products.
4. When using our products, please do not exceed the maximum rating of the products, otherwise the reliability of the whole machine will be affected. There is a certain possibility of failure or malfunction of any semiconductor product under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design, sample and whole machine manufacturing, so as to avoid potential failure risk that may cause personal injury or property loss.
5. It is strongly recommended to identify the trademark when buying our products. Please contact us if there is any question.
6. Product promotion is endless, our company will wholeheartedly provide customers with better products!
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Rev.: 1.1

Revision History:

1. Update electrical diagram and typical test circuit
 2. Update curve template
 3. Update package outline
 4. Update important notice
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Rev.: 1.0

Revision History:

1. First release
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